

Data Sheet

NP-140

- Multifunctional Laminates and Prepregs, Tg 140 °C (DSC)
- Exceptional consistent laminate quality due to exclusive use of Nan Ya's raw materials
- Common PTH process parameters result in very good through hole reliability and copper foil peel strength
- High luminance of Epoxy contrast with Copper for Laser Type AOI
- IPC-4101C specification sheet 21 is applicable

Revision Date: April 2011

NAN YA SPECIFICATION SHEET FOR NP-140 - Medium Tg multifunctional Epoxy Laminates and Prepregs

SPECIFICATION SHEET #: IPC-4101 / 21
 FLAME RETARDANT MECHANISM: RoHS compliant Bromine, UL94 V-0
 FILLERS: N/A
 ID REFERENCE: UL/ANSI: FR-4 / 21

LAMINATE DATA SHEET

Laminate Properties	Specification < 0,50 mm [0,0197 in] 50% RC		Specification ≥ 0,50 mm [0,0197 in] 40% RC		Units metric [English]	Test Method (IPC-TM-650)	Ref. Para.	
	Typical Value	Specification	Typical Value	Specification				
Glass Transition Temperature (Tg) by DSC / TMA	140 ± 5 / 130	≥ 110	140 ± 5 / 130	≥ 110	°C	2.4.25	3.10.1.6	
Decomposition Temperature (Td) TGA 5% wt. loss onset wt. loss	310 305	- -	310 305	- -	°C	2.4.24.6	3.10.1.8	
CTE, z-axis	prior Tg above Tg	- -	50 - 70 270-300	- -	ppm/°C	2.4.24	3.10.1.11	
CTE, x/y-axis	prior Tg above Tg	- -	15 - 18 15 - 18	- -	ppm/°C	2.4.24	3.10.1.11	
Thermal Expansion (50 °C - 260 °C) z-axis	TE	-	4,4	-	%	2.4.24	3.10.1.11	
Thermal Conductivity	λ	-	0,49	-	W/mK	Laser Flash	-	
Thermal Resistance: Time to Delamination	T260 T288	- -	20-30 2 - 5	- -	minutes	2.4.24.1	3.10.1.12	
Pressure Cooker Test - 2 hours (10 s solder dip @ 288 °C)	pass	pass visual	pass	pass visual	pass visual	-	-	
Thermal Stress 10 s at 288 °C [550,4 °F], minimum	A. unetched B. etched	pass pass	pass visual pass visual	pass pass	pass visual pass visual	rating	2.4.13.1	3.10.1.2
CAF Resistance	pass	AABUS	pass	AABUS	pass / fail	2.6.25	3.12.1.4	
Peel Strength, minimum							3.9.1.1	
A. Low profile copper foil and very low profile copper foil - all copper foil >17µm [0,669 mil]	0,88 [5,00]	0,70 [4,00]	0,96 [5,50]	0,70 [4,00]	N/mm [lb/in]	2.4.8		
B. Standard profile copper foil								
1. after thermal stress (35 µm)	1,75 [10,00]	0,80 [4,57]	1,75 [10,00]	1,05 [6,00]	N/mm [lb/in]	2.4.8.2	3.9.1.1.1	
2. at 125 °C [257 °F]	1,22 [7,00]	0,70 [4,00]	1,22 [7,00]	0,70 [4,00]	N/mm [lb/in]	2.4.8.3	3.9.1.1.2	
3. after process solutions	1,13 [6,50]	0,55 [3,14]	1,13 [6,50]	0,80 [4,57]	N/mm [lb/in]	2.4.8	3.9.1.1.3	
C. all other foil - composite	-	AABUS	-	AABUS				
Volume Resistivity, minimum								
A. C-96/35/90	5,0*10 ⁹	10 ⁶	5,9*10 ⁸	-	MΩcm	2.5.17.1	3.11.1.3	
B. after moisture resistance	-	-	-	10 ⁶				
C. at elevated temperature E-24/125	-	10 ³	4,4*10 ⁹	10 ³				
Surface Resistivity, minimum								
A. C-96/35/90	5,0*10 ⁷	10 ⁴	5,0*10 ⁷	-	MΩ	2.5.17.1	3.11.1.4	
B. after moisture resistance	-	-	-	10 ⁴				
C. at elevated temperature E-24/125	-	10 ³	2,0*10 ⁸	10 ³				
Dielectric Breakdown, minimum	60	-	60	40	kV	2.5.6	3.11.1.6	
Electric Strength, minimum	40	30	-	-	kV/mm	2.5.6.2	3.11.1.7	
(laminate & prepreg as laminated)	[1000]	[750]	-	-	[V/mil]		3.11.2.3	
Arc Resistance, minimum	120	60	120	60	s	2.5.1	3.11.1.5	
Comparative Tracking Index (CTI)	3 / 175-249	-	3 / 175-249	-	PLC / V	ASTM D3638	-	
Permittivity, spec. maximum	A. @ 1MHz B. @ 100MHz C. @ 1 GHz D. @ 2 GHz E. @ 5 GHz	4,21 - - - -	5,40 - - - -	4,58 4,32 4,13 4,11 -	5,40 - - - -	- - - - -	2.5.5.2 2.5.5.3 2.5.5.9 2.5.5.5	3.11.1.1 3.11.2.11
Loss Tangent, spec. maximum	A. @ 1MHz B. @ 100MHz C. @ 1 GHz D. @ 2 GHz E. @ 5 GHz	0,021 0,018 0,013 0,012 -	0,035 - - - -	0,019 0,016 0,012 0,011 -	0,035 - - - -	- - - - -	2.5.5.2 2.5.5.3 2.5.5.9 2.5.5.5	3.11.1.2 3.11.2.2
Flexural Strength, minimum	A. Length direction B. Cross direction	- -	- -	500 400	415 [60190] 345 [50040]	N/mm ² [lb/in ²]	2.4.4	3.9.1.3
Flexural Strength at elevated temperature, length direction, minimum	-	-	-	-	N/mm ² [lb/in ²]	2.4.4.1	3.9.1.4	
Dimensional stability x/y-axis E-0,5/170(R)/E-4/105(TL)	0,01 - 0,03	< 0,05	0,01 - 0,03	< 0,05	%	2.4.39	3.9.1.2	
Moisture Absorption, maximum	0,30	-	0,10	0,80	%	2.6.2.1	3.12.1.1	
Flammability (laminate & prepreg as laminated)	V-0	V-0 minimum	V-0	V-0 minimum	rating	UL94	3.10.1.1	
Density (50 % resin content)	1,92	-	1,92	-	g/cm ³	-	-	

PREPREG DATA SHEET

Prepreg Requirements	Typical Value	Specification	Unit	Test Method	Ref. Para.
1. Shelf Life, minimum (Condition 1/ Condition 2)	meets requirements	180 / 90	Days	AABUS	3.17
2. Reinforcement	woven E-glass	as per IPC-4412 or AABUS	-	-	-
3. Volatile content maximum	0,75	0,75	%	2.3.19	3.9.2.8
4. Prepreg Parameters	-	-	AABUS	AABUS	1.1.7
5. Flammability (as laminated)	V-0	V-0 minimum	rating	UL94	3.10.2.1
6. Other					

Data shown are nominal values for reference only, no review according MIL-S-13949

*AABUS = As Agreed upon Between User and Supplier.

all Nan Ya laminates are in conformance with RoHS regulations

NP-140

Prepreg NP-140B

Glass Fabric	Resin Content	Resin Flow	Gel Time @ 170 °C [s]	Thickn. after lamination per ply [μm] ¹⁾	@ 1 MHz ²⁾		@ 1 GHz ²⁾	
	[%]	[%]			Dk	Df	Dk	Df
106	68 ± 3	40 ± 5	130 ± 20	39 ± 8	3,74	0,015	3,58	0,011
106MR	72 ± 3	43 ± 5		47 ± 8	3,61	0,016	3,46	0,012
106HR	74 ± 3	46 ± 5		52 ± 8	3,54	0,015	3,39	0,011
1080	62 ± 3	38 ± 5		69 ± 8	3,94	0,017	3,76	0,012
1080MR	65 ± 3	43 ± 5		77 ± 8	3,84	0,015	3,67	0,011
1080HR	68 ± 3	47 ± 5		86 ± 8	3,74	0,017	3,58	0,013
2112	60 ± 3	37 ± 5		99 ± 8	4,01	0,016	3,83	0,011
2113	56 ± 3	32 ± 5		96 ± 10	4,14	0,015	3,95	0,012
2116	50 ± 3	25 ± 5		111 ± 10	4,34	0,016	4,14	0,012
2116MR	54 ± 3	30 ± 5		124 ± 10	4,21	0,015	4,01	0,011
2116HR	58 ± 3	35 ± 5		136 ± 10	4,07	0,017	3,89	0,013
1506	48 ± 3	25 ± 5		166 ± 10	4,41	0,015	4,20	0,011
1506MR	52 ± 3	30 ± 5		185 ± 10	4,27	0,015	4,07	0,013
7628	43 ± 3	20 ± 5		190 ± 10	4,57	0,017	4,35	0,012
7628MR	47 ± 3	25 ± 5		210 ± 10	4,44	0,017	4,23	0,013
7628HR	50 ± 3	28 ± 5		227 ± 10	4,34	0,016	4,14	0,012

¹⁾ acc. recommended press cycle, 75 % remaining copper, 1 oz

²⁾ data shown are actual values and are not guaranteed

Revision date: April 2011

Recommended press cycle

